

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT APPLICATION of

Takaaki SASAKI

[Group Art Unit: 2822] #41/a

New Divisional of Serial No. 09/062,720

[Examiner: T. M. Arroyo] 12-3000

Filed: October 13, 2000

For: SEMICONDUCTOR DEVICE, SEMICONDUCTOR PACKAGE FOR USE
THEREIN, AND MANUFACTURING METHOD THEREOF

Payton

PRELIMINARY AMENDMENTHonorable Assistant Commission of Patents and Trademarks,
Washington, D.C. 20231

Sir:

Preliminary to the examination of the above-identified application, please enter the following amendments and consider the following remarks:

In the Abstract

Kindly amend the Abstract of the Disclosure as follows:

~~Line 2~~, change "comprised of" to -- includes -- .

~~Line 3~~, change "element" to -- chip -- .

~~Line 4~~, change "through" to -- elongate opening -- .

~~Line 5~~, delete "hall"; and change "element" to -- chip -- .